

Symbol	Parameter					Ratings		s	Unit		
SV _{CER}	Collector to Emitter Breakdown Voltage			(I _C = 1mA)			400			V	
V _{ECS}	Emitter to Collector Voltage - Reverse Ba						28			V	
SCIS25	Self Clamping Inductive Switching Energy (Note 1)						335		mJ		
SCIS150	Self Clamping Inductive Switching Energy (Note 2)					195			mJ		
25	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 25°C					26.9		Α			
:110	Collector Current Continuous, at V _{GE} = 4.0V, T _C = 110°C					25		Α			
GEM	Gate to Emitter Voltage Continuous					±10		V			
D	Power Dis	Power Dissipation Total, at $T_C = 25^{\circ}C$					166		W		
)	Power Dis	Power Dissipation Derating, for T _C > 25 ^o C				1.1			W/º(
J	Operating Junction Temperature Range					-40 to +1		75	°C		
STG	Storage Junction Temperature Range					-4	0 to +1	75	°C		
-	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)						300		°C		
PKG	Max. Lead Temp. for Soldering (Package Body for 10s)					260			°C		
SD	Electrosta	tic Discharge Voltage	at100pl	-, 1500Ω					4		kV
acka	ge Mar	king and Ord	ering	Inform	nation						
Device	Marking	Device	Pa	ckage	Reel Size		Tape V	Vidth		Quant	itv
	3440G2	FGD3440G2 F085		D252	330mm		16m			2500 u	-
					1						
lectr	ical Ch	aracteristics [·]	T _A = 25°	°C unless o	otherwise noted						
-		Parameter cteristics		$I_{CF} = 2mA$	Test Conditi	ions		Min	Тур	Max	Unit
Symbol Off Stat ^{3V} CER	te Chara	Parameter	Voltage	R _{GE} = 1K T _J = -40 te	A, V _{GE} = 0, Ω, o 150°C	ions		Min 370	Тур 400	Max 430	Units V
Off Stat	te Chara	Parameter cteristics		$R_{GE} = 1K_{T_J} = -40 \text{ to}$ $I_{CE} = 10m_{GE} = 0,$	A, V _{GE} = 0, Ω, ο 150°C hA, V _{GE} = 0V,	ions					
off Stat SV _{CER} SV _{CES}	te Chara Collector t Collector t	Parameter cteristics o Emitter Breakdown	Voltage	$\label{eq:R_GE} \begin{array}{l} {\sf R}_{\rm GE} = 1{\sf K} \\ {\sf T}_{\rm J} = -40 \ {\sf tr} \\ {\sf I}_{\rm CE} = 10{\sf m} \\ {\sf R}_{\rm GE} = 0, \\ {\sf T}_{\rm J} = -40 \ {\sf tr} \end{array}$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C nA, $V_{GE} = 0V$,	ions		370	400	430	V
V _{CER} V _{CER} V _{CES}	te Chara Collector t Collector t Emitter to	Parameter cteristics o Emitter Breakdown o Emitter Breakdown	Voltage Voltage	$\begin{aligned} R_{GE} &= 1K\\ T_J &= -40 \text{ tr}\\ I_{CE} &= 10m\\ R_{GE} &= 0,\\ T_J &= -40 \text{ tr}\\ I_{CE} &= -20m \end{aligned}$	A, $V_{GE} = 0$, Ω , to 150°C A, $V_{GE} = 0V$, to 150°C mA, $V_{GE} = 0V$,			370 390	400	430	V V
W _{CER} W _{CES} W _{ECS}	te Chara Collector t Collector t Emitter to Gate to Er	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown nitter Breakdown Volt	Voltage Voltage age	$\begin{split} R_{GE} &= 1K\\ T_J &= -40 \text{ tr}\\ I_{CE} &= 10\text{m}\\ R_{GE} &= 0,\\ T_J &= -40 \text{ tr}\\ I_{CE} &= -20\text{r}\\ T_J &= 25^\circ\text{C}\\ I_{GES} &= \pm 2 \end{split}$	A, $V_{GE} = 0$, Ω , to 150°C A, $V_{GE} = 0V$, to 150°C mA, $V_{GE} = 0V$,	TJ = 2		370 390 28	400 420 -	430	v v v
Off Star BV _{CER} BV _{CES} BV _{ECS} BV _{GES}	te Chara Collector t Collector t Emitter to Gate to Er	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown	Voltage Voltage age	$\begin{split} R_{GE} &= 1K\\ T_J &= -40 \text{ tr}\\ I_{CE} &= 10\text{m}\\ R_{GE} &= 0,\\ T_J &= -40 \text{ tr}\\ I_{CE} &= -20\text{r}\\ T_J &= 25^\circ\text{C}\\ I_{GES} &= \pm 2 \end{split}$	A, $V_{GE} = 0$, Ω , to 150°C tA, $V_{GE} = 0V$, to 150°C mA, $V_{GE} = 0V$, the mA	$T_{J} = 2$ $T_{J} = 1$	50°C	370 390 28	400 420 - ±14	430 450 -	v v v
BV _{CER} BV _{CES} BV _{ECS} BV _{GES} CER	te Chara Collector t Collector t Emitter to Gate to Er Collector t	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown nitter Breakdown Volt o Emitter Leakage Cu	Voltage Voltage age urrent	$\begin{split} R_{GE} &= 1K\\ T_J &= -40 \text{ tr}\\ I_{CE} &= 10\text{m}\\ R_{GE} &= 0,\\ T_J &= -40 \text{ tr}\\ I_{CE} &= -20\text{r}\\ T_J &= 25^\circ\text{C}\\ I_{GES} &= \pm 2 \end{split}$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$	50°C 25°C	370 390 28 ±12 -	400 420 - ±14 -	430 450 - 25	V V V μΑ mA
Dff Stat BV _{CER} BV _{CES} BV _{ECS} BV _{GES} CER	te Chara Collector t Collector t Emitter to Gate to Er Collector t	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown nitter Breakdown Volt	Voltage Voltage age urrent	$R_{GE} = 1K$ $T_{J} = -40 \text{ to}$ $I_{CE} = 10m$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to}$ $I_{CE} = -20r$ $T_{J} = 25^{\circ}C$ $I_{GES} = \pm 2$ $V_{CE} = 250$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$	50°C	370 390 28 ±12 -	400 420 - ±14 -	430 450 - - 25 1	ν ν ν μΑ
Dff Stat SV _{CER} SV _{CES} SV _{ECS} SV _{GES} CER ECS R1	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu te Resistance	Voltage Voltage age urrent	$R_{GE} = 1K$ $T_{J} = -40 \text{ to}$ $I_{CE} = 10m$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to}$ $I_{CE} = -20r$ $T_{J} = 25^{\circ}C$ $I_{GES} = \pm 2$ $V_{CE} = 250$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$	50°C 25°C	370 390 28 ±12 - - - - - -	400 420 - ±14 -	430 450 - 25 1 1 40 -	V V V μΑ mA
Off Stat	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt nitter Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu	Voltage Voltage age urrent	$R_{GE} = 1K$ $T_{J} = -40 \text{ to}$ $I_{CE} = 10m$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to}$ $I_{CE} = -20r$ $T_{J} = 25^{\circ}C$ $I_{GES} = \pm 2$ $V_{CE} = 250$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$	50°C 25°C	370 390 28 ±12 - - - -	400 420 - ±14 - - -	430 450 - 25 1 1	V V V µA mA mA
Dff Stat SV _{CER} SV _{CES} SV _{ECS} SV _{GES} CER ECS R1 R2	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga Gate to Er	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu te Resistance nitter Resistance	Voltage Voltage age urrent	$R_{GE} = 1K$ $T_{J} = -40 \text{ to}$ $I_{CE} = 10m$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to}$ $I_{CE} = -20r$ $T_{J} = 25^{\circ}C$ $I_{GES} = \pm 2$ $V_{CE} = 250$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$	50°C 25°C	370 390 28 ±12 - - - - - -	400 420 - ±14 - - - 120	430 450 - 25 1 1 40 -	V V V μΑ mA Ω
Pff Stat V _{CER} V _{CES} V _{ECS} V _{GES} CER ECS R 22 Pn Stat	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga Gate to Er te Chara	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu te Resistance nitter Resistance cteristics	Voltage Voltage age urrent urrent	$R_{GE} = 1K$ $T_{J} = -40 to$ $I_{CE} = 10m$ $R_{GE} = 0,$ $T_{J} = -40 to$ $I_{CE} = -20r$ $T_{J} = 25^{\circ}C$ $I_{GES} = \pm 2t$ $V_{CE} = 250$ $V_{EC} = 24V$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$ V,	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$ $T_{J} = 1$	50°C 25°C 50°C	370 390 28 ±12 - - - - 10K	400 420 - ±14 - - 120 -	430 450 - 25 1 1 40 - 30K	V V V μΑ mA Ω Ω
ff Stat V _{CER} V _{CES} V _{ECS} V _{GES} ECS ECS ECS ECS ECS ECS ECS ECS ECS ECS	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga Gate to Er te Chara Collector t	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu Collector Leakage Cu te Resistance nitter Resistance cteristics o Emitter Saturation V	Voltage age urrent urrent	$R_{GE} = 1K T_{J} = -40 to T_{CE} = 10m R_{GE} = 0, T_{J} = -40 to T_{CE} = -20m T_{J} = 25^{\circ}C$ $I_{GES} = \pm 22 V_{CE} = 250 V_{CE} = 250 V_{CE} = 24 V_{CE} = $	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$ V, $V_{GE} = 4V$,	$\begin{array}{c} T_{J} = 2\\ T_{J} = 1\\ T_{J} = 2\\ T_{J} = 1\\ T_{J} = 2\\ T_{J} = 1\\ \end{array}$	50°C 25°C 50°C 25°C	370 390 28 ±12 - - - 10K	400 420 - ±14 - - 120 - 1.1	430 450 - 25 1 1 40 - 30K 1.2	V V V μA mA Ω Ω
off Stat V _{CER} V _{CES} V _{ECS} V _{GES} CER ECS 1 22	te Chara Collector t Collector t Emitter to Gate to Er Collector t Emitter to Series Ga Gate to Er te Chara Collector t	Parameter cteristics o Emitter Breakdown o Emitter Breakdown Collector Breakdown Volt o Emitter Leakage Cu Collector Leakage Cu te Resistance nitter Resistance cteristics	Voltage age urrent urrent /oltage /oltage	$R_{GE} = 1K T_{J} = -40 to T_{CE} = 10m R_{GE} = 0, T_{J} = -40 to T_{CE} = -20n T_{J} = 25^{\circ}C$ $I_{GES} = \pm 20 V_{CE} = 250 V_{CE} = 250 V_{CE} = 24 V_{CE} = 24 V_{CE} = 24 V_{CE} = 10A$	A, $V_{GE} = 0$, Ω , o 150°C A, $V_{GE} = 0V$, o 150°C mA, $V_{GE} = 0V$, mA DV, $R_{GE} = 1K\Omega$ V,	$T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$ $T_{J} = 1$ $T_{J} = 2$ $T_{J} = 1$	50°C 25°C 50°C	370 390 28 ±12 - - - - 10K	400 420 - ±14 - - 120 -	430 450 - 25 1 1 40 - 30K	V V V μΑ mA Ω

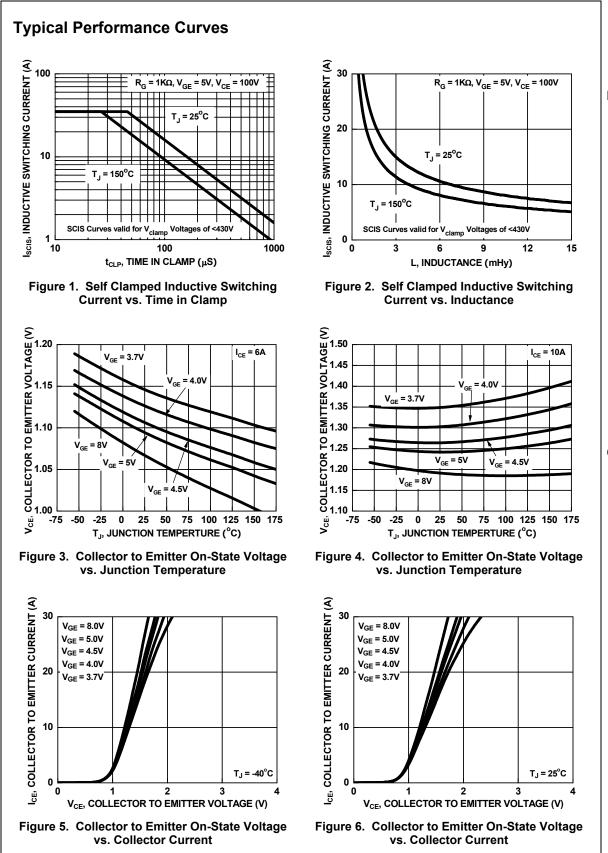
Symbol	Parameter	Test Condi	tions	Min	Тур	Мах	Units
Dynam	ic Characteristics						
Q _{G(ON)}	Gate Charge	I _{CE} = 10A, V _{CE} = 12V, V _{GE} = 5V		-	24	-	nC
1	Gate to Emitter Threshold Voltage	I_{CE} = 1mA, V_{CE} = V_{GE} ,	$T_J = 25^{\circ}C$	1.3	1.7	2.2	v
/ _{GE(TH)}	Gate to Enlitter Threshold Voltage		T _J = 150 ^o C	0.75	1.2	1.8	v
/ _{GEP}	Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A		-	2.8	-	V
d(ON)R	ing Characteristics Current Turn-On Delay Time-Resistive	V _{CE} = 14V, R _L = 1Ω		-	1.0	4	μS
	Current Rise Time-Resistive	V _{GE} = 5V, R _G = 1KΩ T _J = 25 ^o C,		-	2.0	7	μS
R		0					
	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L = 1mH,		-	5.3	15	μS
t _{rR} t _{d(OFF)L} t _{fL}	Current Turn-Off Delay Time-Inductive Current Fall Time-Inductive			-	5.3 2.3	15 15	μs μs
d(OFF)L	,	V _{CE} = 300V, L = 1mH, V _{GE} = 5V, R _G = 1KΩ				_	

Notes:

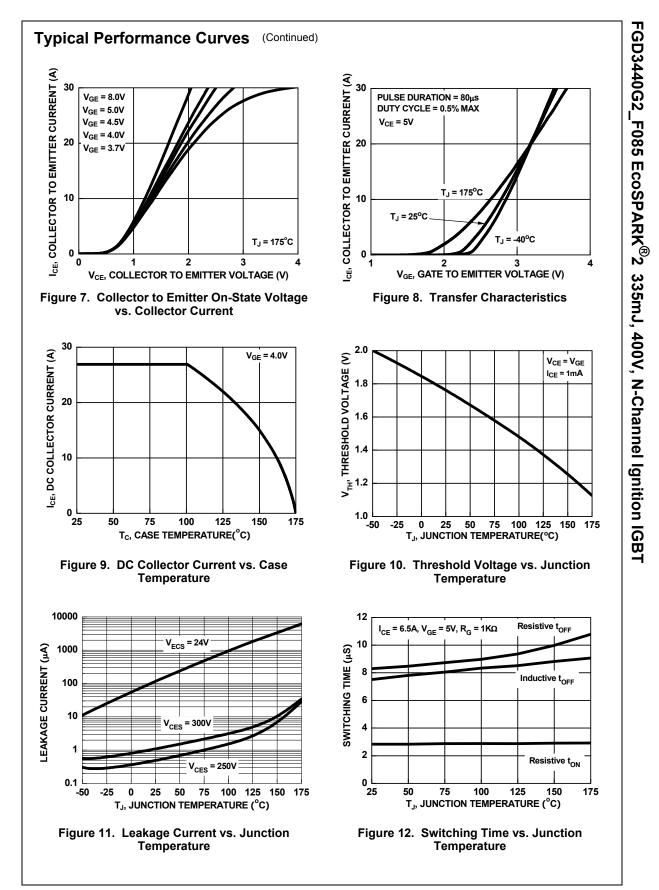
1: Self Clamping Inductive Switching Energy(Escis25) of 335mJ is based on the test conditions that is starting T_J=25 °C; L=3mHy, I_{SCIS}=15A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp

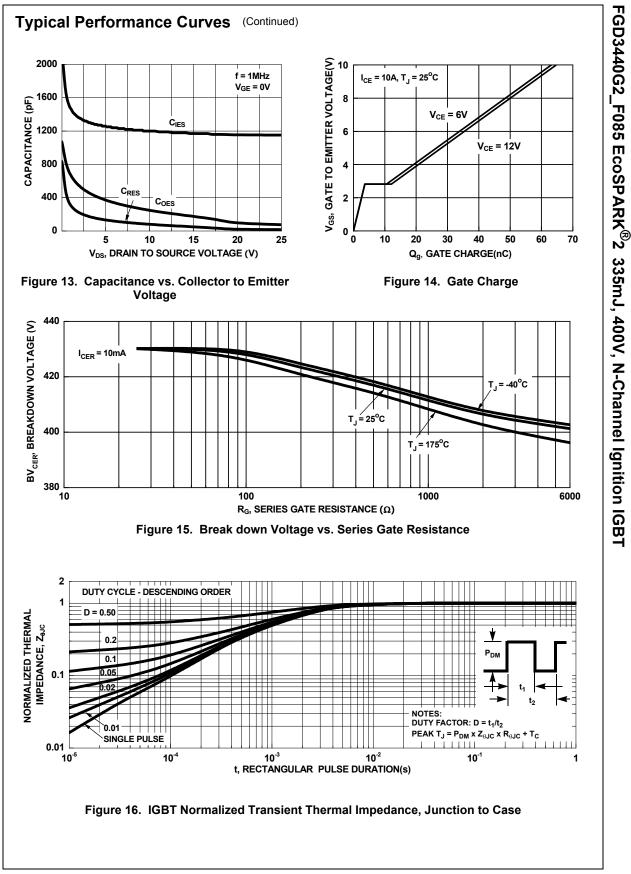
2: Self Clamping Inductive Switching Energy (Escis150) of 195mJ is based on the test conditions that is starting T_J =150 °C; L=3mHy, Iscis=11.4A,Vcc=100V during inductor charging and Vcc=0V during the time in clamp.

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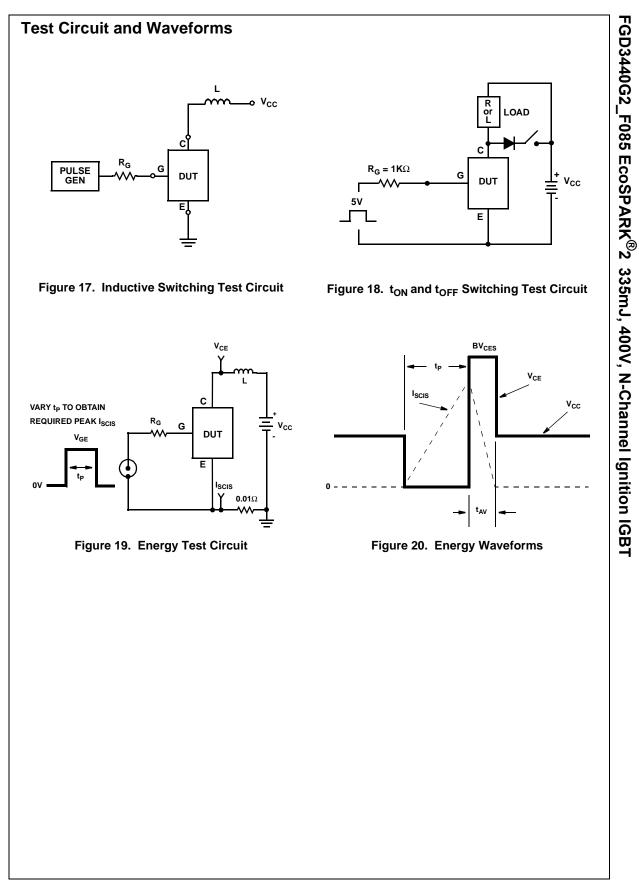


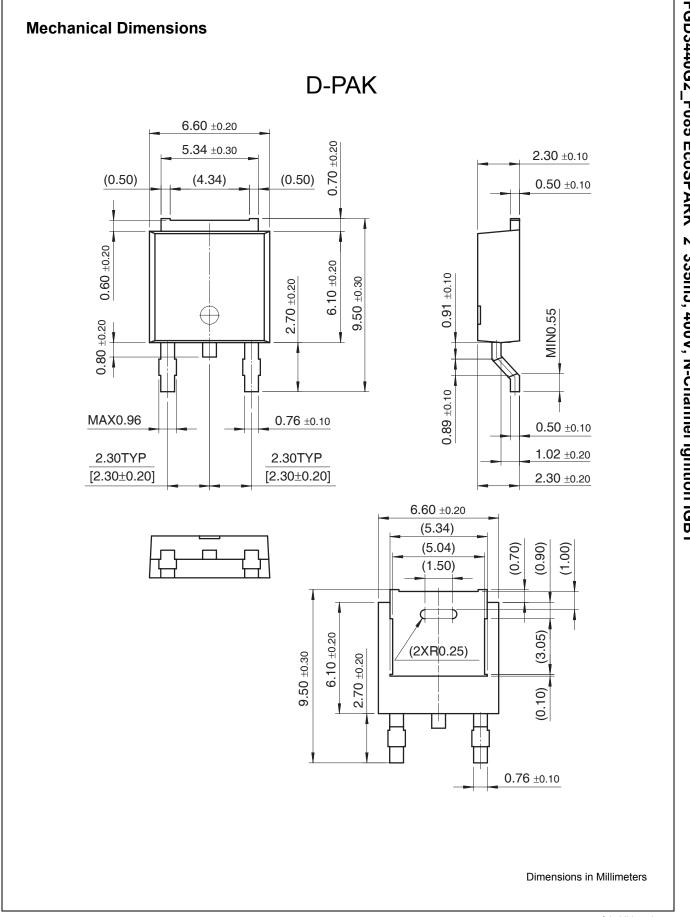
FGD3440G2_F085 EcoSPARK[®]2 335mJ, 400V, N-Channel Ignition IGBT





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